

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: H. KOMATSU et al.
Serial No: 10/594,548
Filed: SEPTEMBER 27, 2006
Title: HEAT-RESISTANT PHOTSENSITIVE RESIN
COMPOSITION, METHOD FOR FORMING PATTERN USING
THE COMPOSITION, AND ELECTRONIC PART
Group AU: 1795
Examiner: John S. Y. Chu
Confirm. No: 3540

**INFORMATION DISCLOSURE STATEMENT
UNDER 37 CFR 1.97 AND 1.98****Mail Stop: AMEND – NO FEE**

Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

December 2, 2008

Sir:

Pursuant to Applicants' duty of disclosure, enclosed please find a copy of an Official Action dated September 2, 2008, issued in a corresponding Japanese patent application, together with a partial English translation thereof. Also enclosed are copies of the four references cited in this Official Action, together with partial English translations of each. Still further enclosed is a Form PTO/SB/08A, listing the enclosed documents.

Attention is respectfully directed to the enclosed JP 2003-330167. This reference, together with an English-language Abstract thereof, has previously been submitted for consideration by the Examiner, with the Information Disclosure Statement submitted September 27, 2006, upon originally filing the above-identified

application. This reference is listed herein in light of the partial English translation being submitted herewith.

This Information Disclosure Statement is being submitted subsequent to a first Office Action on the merits in the above-identified application, but prior to a Final Office Action or issuance of a Notice of Allowance, or issuance of any other action closing prosecution on the merits. For satisfying requirements of 37 CFR 1.97(c), and noting the partial English translation thereof submitted herewith, the following Statement is made under 37 CFR 1.97(e):

Each item of information contained in this Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement.

To the extent that the enclosed documents are not in English, it is respectfully submitted that requirements of 37 CFR 1.98(a)(3) are satisfied by the partial English translations of each of the enclosed documents; and, with respect to the cited documents in the enclosed Official Action, in addition by the partial English translation of the Official Action.

In view of the foregoing, it is respectfully submitted that all applicable requirements of 37 CFR 1.97 and 1.98 have been satisfied, in connection with present submission of the enclosed documents. Consideration of the enclosed documents, upon further examination of the above-identified application, is respectfully requested.

Please charge any shortage of fees due in connection with the filing of this paper to the Deposit Account of Antonelli, Terry, Stout & Kraus, LLP, Deposit

Account No. 01-2135 (case No. 1270.46593X00), or credit any excess fees paid to
such Deposit Account.

Respectfully submitted,

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